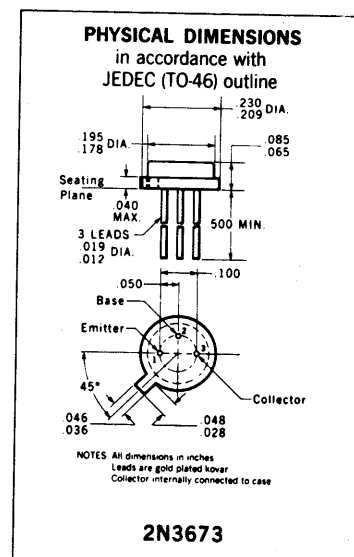
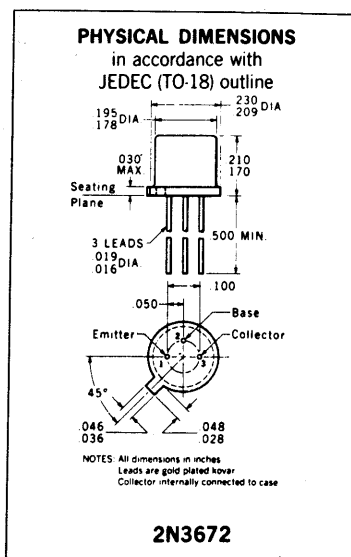
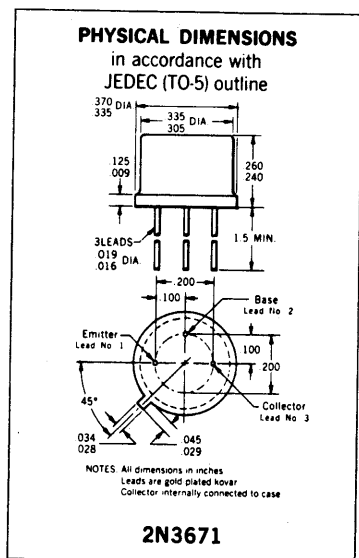


2N3671 • 2N3672 • 2N3673

PNP HIGH-SPEED SWITCHES AND CORE DRIVERS

DIFFUSED SILICON PLANAR EPITAXIAL TRANSISTORS

FOR IMPROVED PERFORMANCE SEE FAIRCHILD 2N3502 • 2N3503



GENERAL DESCRIPTION - The 2N3671, 2N3672 and 2N3673 are PNP silicon Planar epitaxial transistors designed primarily for high-speed saturated switching, line drivers and memory applications.

ABSOLUTE MAXIMUM RATINGS (Note 1)

Maximum Temperatures

Storage Temperature

-65°C to +200°C

Operating Junction Temperature

200°C Maximum

Maximum Power Dissipation (Notes 2 and 3)

Total Dissipation at 25°C Case Temperature

2N3671

3.0 Watts

2N3672

1.8 Watts

2N3673

3.0 Watts

at 25°C Ambient Temperature

0.6 Watt

0.4 Watt

0.35 Watt

Maximum Voltages and Current

V_{CBO} Collector to Base Voltage

-60 Volts

V_{CEO} Collector to Emitter Voltage (Note 4)

-50 Volts

V_{EBO} Emitter to Base Voltage

-5.0 Volts

I_C Collector Current (Note 2)

600 mA

ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature unless otherwise noted)

Symbol	Characteristic	Min.	Max.	Units	Test Conditions
h_{FE}	DC Pulse Current Gain (Note 5)	75	225		$I_C = 150 \text{ mA}$ $V_{CE} = -10 \text{ V}$
h_{FE}	DC Current Gain	75			$I_C = 1.0 \text{ mA}$ $V_{CE} = -10 \text{ V}$
h_{FE}	DC Pulse Current Gain (Note 5)	75			$I_C = 10 \text{ mA}$ $V_{CE} = -10 \text{ V}$
h_{FE}	DC Current Gain	55			$I_C = 0.1 \text{ mA}$ $V_{CE} = -10 \text{ V}$
h_{FE}	DC Pulse Current Gain (Note 5)	40			$I_C = 500 \text{ mA}$ $V_{CE} = -10 \text{ V}$
h_{FE}	DC Pulse Current Gain (Note 5)	20			$I_C = 150 \text{ mA}$ $V_{CE} = -0.6 \text{ V}$

FAIRCHILD
SEMICONDUCTOR
A DIVISION OF FAIRCHILD CAMERA AND INSTRUMENT CORPORATION

FAIRCHILD TRANSISTORS 2N3671•2N3672•2N3673

ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature unless otherwise noted)

Symbol	Characteristic	Min.	Max.	Units	Test Conditions
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 5)		-0.4	Volts	$I_C = 150 \text{ mA}$ $I_B = 15 \text{ mA}$
$V_{CE(sat)}$	Pulsed Collector Saturation Voltage (Note 5)		-1.6	Volts	$I_C = 500 \text{ mA}$ $I_B = 50 \text{ mA}$
$V_{BE(sat)}$	Pulsed Base Saturation Voltage (Note 5)		-1.3	Volts	$I_C = 150 \text{ mA}$ $I_B = 15 \text{ mA}$
$V_{BE(sat)}$	Pulsed Base Saturation Voltage (Note 5)		-2.6	Volts	$I_C = 500 \text{ mA}$ $I_B = 50 \text{ mA}$
t_d	Turn-On Delay Time (See Figure 1)		10	ns	$I_{CS} = 150 \text{ mA}$ $I_{B1} = 15 \text{ mA}$
t_r	Rise Time (See Figure 1)		40	ns	$I_{CS} = 150 \text{ mA}$ $I_{B1} = 15 \text{ mA}$
t_s	Storage Time (See Figure 2)		80	ns	$I_{CS} = 150 \text{ mA}$, $I_{B1} = 15 \text{ mA}$, $I_{B2} = -15 \text{ mA}$
t_f	Fall Time (See Figure 2)		30	ns	$I_{CS} = 150 \text{ mA}$, $I_{B1} = 15 \text{ mA}$, $I_{B2} = -15 \text{ mA}$
t_{on}	Turn On Time (See Figure 1)		45	ns	$I_{CS} = 150 \text{ mA}$ $I_{B1} = 15 \text{ mA}$
t_{off}	Turn Off Time (See Figure 2)		100	ns	$I_{CS} = 150 \text{ mA}$ $I_{B1} = 15 \text{ mA}$, $I_{B2} = -15 \text{ mA}$
h_{fe}	High Frequency Current ($f = 100 \text{ MHz}$)	2.0			$I_C = 50 \text{ mA}$ $V_{CE} = -20 \text{ V}$
I_{CBO}	Collector Cutoff Current		10	nA	$I_E = 0$ $V_{CB} = -50 \text{ V}$
$I_{CBO(150^\circ\text{C})}$	Collector Cutoff Current		10	μA	$I_E = 0$ $V_{CB} = -50 \text{ V}$
I_{CEX}	Collector Reverse Current		50	nA	$V_{CE} = -30 \text{ V}$ $V_{BE} = +0.5 \text{ V}$
I_B	Base Current		50	nA	$V_{CE} = -30 \text{ V}$ $V_{BE} = +0.5 \text{ V}$
C_{obo}	Output Capacitance		9.0	pF	$I_E = 0$ $V_{CB} = -10 \text{ V}$
C_{ibo}	Input Capacitance		30	pF	$I_C = 0$ $V_{EB} = -2.0 \text{ V}$
BV_{CBO}	Collector to Base Breakdown Voltage	-60		Volts	$I_C = 10 \text{ } \mu\text{A}$ $I_E = 0$
$V_{CEO(sust)}$	Collector to Emitter Sustaining Voltage (Notes 4 and 5)	-50		Volts	$I_C = 10 \text{ mA}$ $I_B = 0$ (pulsed)
BV_{EBO}	Emitter to Base Breakdown Voltage	-5.0		Volts	$I_C = 0$ $I_E = 10 \text{ } \mu\text{A}$

NOTES:

- (1) These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
- (2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
- (3) These ratings give a maximum junction temperature of 200°C and junction to case thermal resistance of 58.3°C/watt (derating factor of 17.2 mW/°C); junction to ambient thermal resistance of 292°C/watt (derating factor of 3.43 mW/°C) for the 2N3671. Junction to case thermal resistance of 97.3°C/watt (derating factor of 10.3 mW/°C); junction to ambient thermal resistance of 437°C/watt (derating factor of 2.28 mW/°C) for the 2N3672. Junction to case thermal resistance of 58.3°C/watt (derating factor of 17.2 mW/°C); junction to ambient thermal resistance of 500°C/watt (derating factor of 2.0 mW/°C).
- (4) Rating refers to a high current point where collector to emitter voltage is lowest.
- (5) Pulse Conditions: length = 300 μsec ; duty cycle = 1%.

FIGURE 1

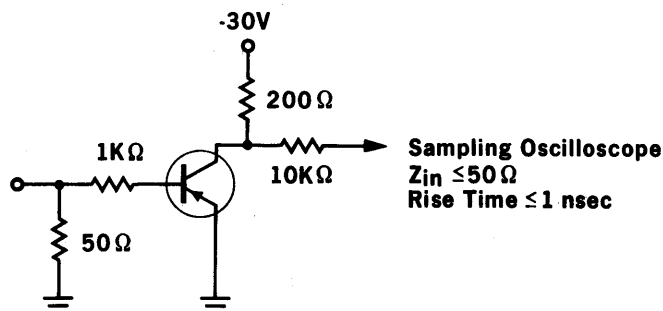
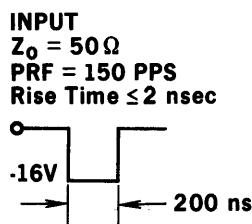
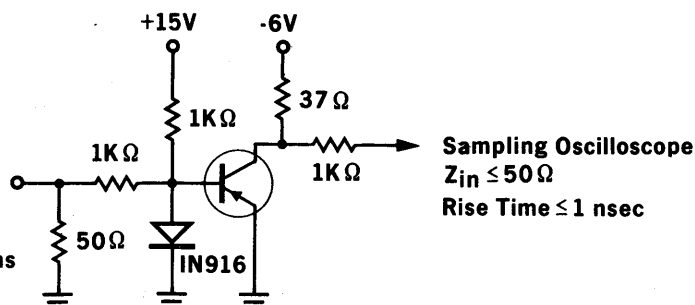
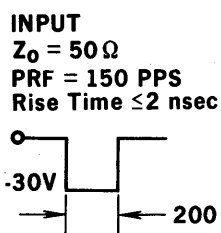


FIGURE 2



2N3688 • 2N3689 • 2N3690

NPN RF-AGC AMPLIFIERS

SILICON PLANAR TRANSISTORS

The 2N3688, 2N3689, and 2N3690 are NPN silicon PLANAR transistors designed specifically for commercial RF-IF-AGC applications. They feature high power gain, low noise, and excellent forward AGC characteristics in a solid package designed to give maximum mechanical support to the transistor chip.

ABSOLUTE MAXIMUM RATINGS [Note 1]

Maximum Temperatures

Operating Junction Temperature
Storage Temperature
Soldering Temperature

125°C Maximum
-55°C to +125°C
260°C Maximum

Maximum Power Dissipation

Total Dissipation at 25°C Case Temperature [Note 2]
at 65°C Case Temperature [Note 2]
at 25°C Ambient Temperature [Note 2]

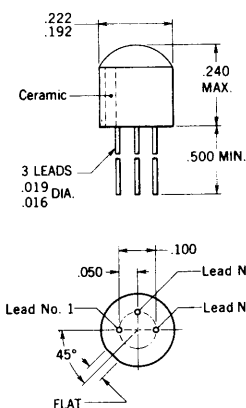
0.5 Watt
0.3 Watt
0.2 Watt

Maximum Voltages

V_{CBO} Collector to Base Voltage
 V_{CEO} Collector to Emitter Voltage [Note 3]
 V_{EBO} Emitter to Base Voltage

40 Volts
40 Volts
4.0 Volts

PHYSICAL DIMENSIONS Epoxy package TO-106



NOTES: All dimensions in inches.
All leads electrically isolated from case.

ELECTRICAL CHARACTERISTICS (25°C free air temperature unless otherwise noted)

Symbol	Characteristics	2N3688			2N3689			2N3690			Units	TEST CONDITIONS	
		Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.			
C_{ob}	Output Capacitance	1.1		1.6	1.1		1.6	1.1		1.6	pf	$I_E = 0$	$V_{CB} = 10\text{ V}$
C_{cb}	Guarded Output Capacitance	0.8			0.8			0.8			pf	$I_E = 0$	$V_{CB} = 10\text{ V}$
NF	Noise Figure [Note 5]							4.0		5.5	db	$I_C = 4.0\text{ mA}$	$V_{CE} = 10\text{ V}$
h_{fe}	High Frequency Current Gain ($f = 100\text{ mc}$)	4.0	6.0		4.0	6.0		4.0	6.0			$I_C = 4.0\text{ mA}$	$V_{CE} = 10\text{ V}$
PG_1	Power Gain ($f = 45\text{ mc}$)	29	33		29	33					db	$I_C = 4.0\text{ mA}$	$V_{CE} = 10\text{ V}$
PG_2	Power Gain ($f = 200\text{ mc}$)							15	18		db	$I_C = 4.0\text{ mA}$	$V_{CE} = 10\text{ V}$
AGC ₁	Automatic Gain Control ($f = 45\text{ mc}$) [Note 6]	8.0		10.5	9.5		12				mA	I_C for which $P_o = P_{s1}$ -30 db in 45 mc test circuit	
AGC ₂	Automatic Gain Control ($f = 200\text{ mc}$) [Note 6]							9.0		14	mA	I_C for which $P_o = P_{s2}$ -30 db in 200 mc test circuit	
$r_{b'C_e}$	Collector-Base Time Constant ($f = 80\text{ mc}$)			15			15			15	psec	$I_C = 4.0\text{ mA}$	$V_{CE} = 10\text{ V}$

NOTES:

- These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
- These ratings give a maximum junction temperature of 125°C and junction-to-case thermal resistance of 200°C/Watt (derating factor of 5.0 mW/°C); junction-to-ambient thermal resistance of 500°C/Watt (derating factor of 2.0 mW/°C).
- Rating refers to a high-current point where collector-to-emitter voltage is lowest.
- Pulse Conditions: length = 300 μ sec; duty cycle = 1%.
- $f = 200\text{ mc}$; $R_s = 100\Omega$; BW = 1.0 mc.
- Additional AGC information on page 2.

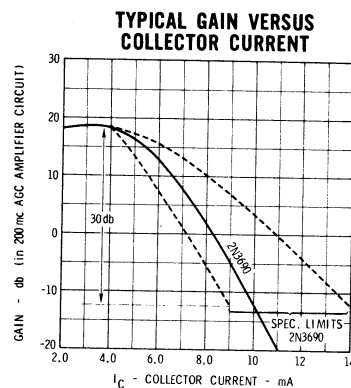
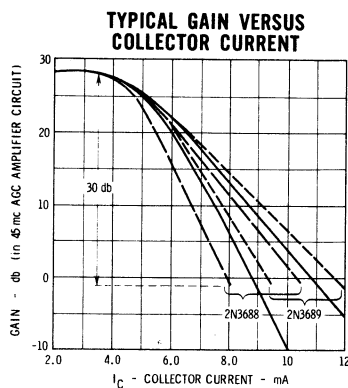
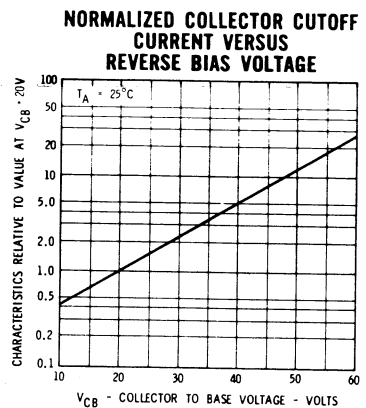
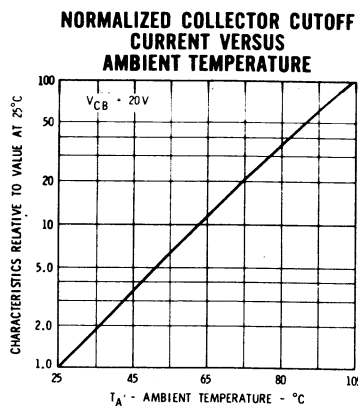
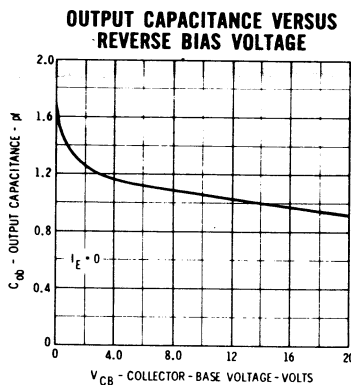
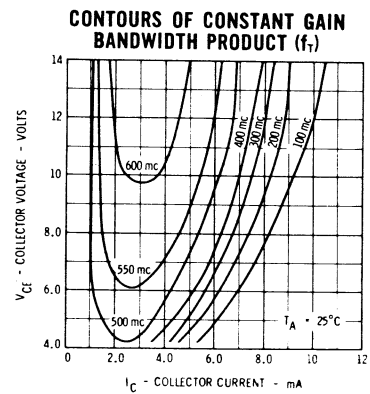
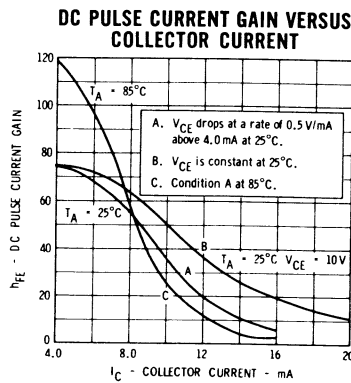
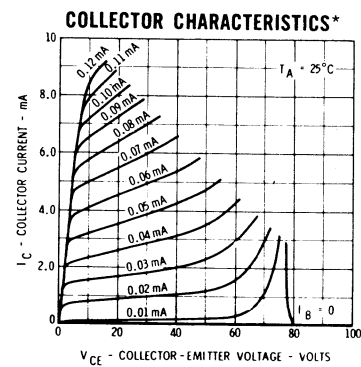
FAIRCHILD
SEMICONDUCTOR
A DIVISION OF FAIRCHILD CAMERA AND INSTRUMENT CORPORATION

313 FAIRCHILD DRIVE, MOUNTAIN VIEW, CALIFORNIA, (415) 962-5011, TWX: 910-379-6435

ELECTRICAL CHARACTERISTICS (25°C free air temperature unless otherwise noted)

Symbol	Characteristics	2N3688			2N3689			2N3690			Units	TEST CONDITIONS
		Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.		
h_{FE}	DC Pulse Current Gain [Note 4]	30	70		30	70		30	70			$I_C = 4.0 \text{ mA}$ $V_{CE} = 10 \text{ V}$
I_{CBO}	Collector Cutoff Current			50			50			50	nA	$I_E = 0$ $V_{CB} = 20 \text{ V}$
$I_{CBO} (65^\circ\text{C})$	Collector Cutoff Current			5.0			5.0			5.0	μA	$I_E = 0$ $V_{CB} = 20 \text{ V}$
BV_{CBO}	Collector to Base Breakdown Voltage	40			40			40			Volts	$I_C = 100 \mu\text{A}$ $I_E = 0$
$V_{CEO} (\text{sust})$	Collector to Emitter Sustaining Voltage [Notes 3 and 4]	40			40			40			Volts	$I_C = 3.0 \text{ mA}$ $I_E = 0$ (Pulsed)
BV_{EBO}	Emitter to Base Breakdown Voltage	4.0			4.0			4.0			Volts	$I_E = 100 \mu\text{A}$ $I_C = 0$

TYPICAL ELECTRICAL CHARACTERISTICS



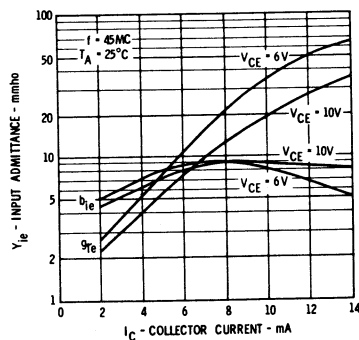
* Single family characteristics on Transistor Curve Tracer

TYPICAL SMALL SIGNAL COMMON EMITTER "Y" PARAMETERS

2N3688 • 2N3689

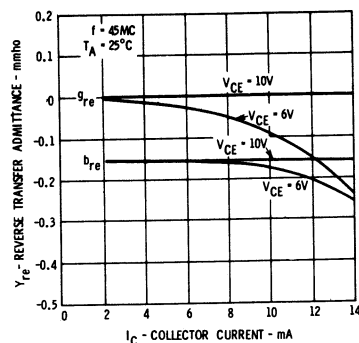
45 mc

vs. COLLECTOR CURRENT



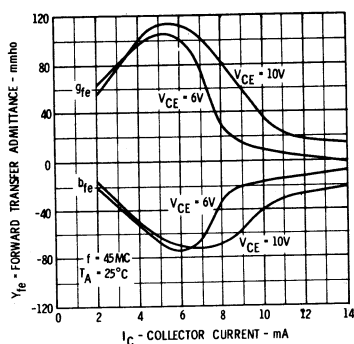
y_{ie}

Input Admittance
(output short circuit)



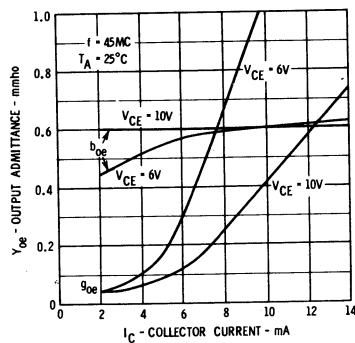
y_{re}

Reverse
Transfer Admittance
(input short circuit)



y_{fe}

Forward
Transfer Admittance
(output short circuit)



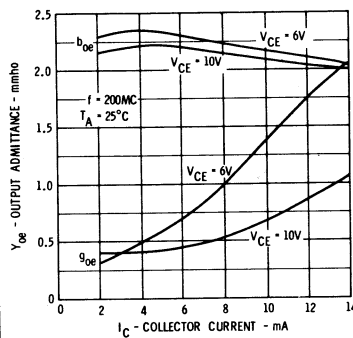
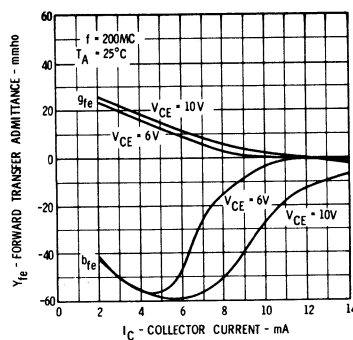
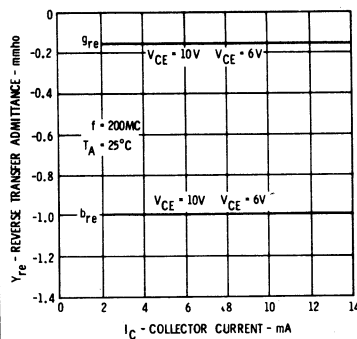
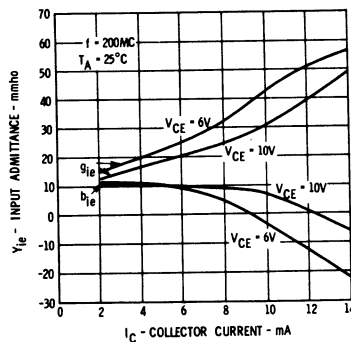
y_{oe}

Output Admittance
(input short circuit)

2N3690

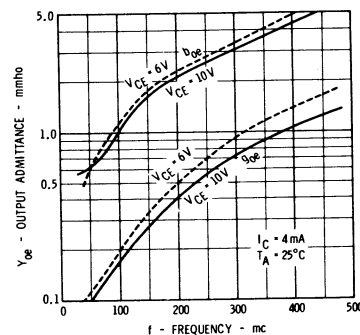
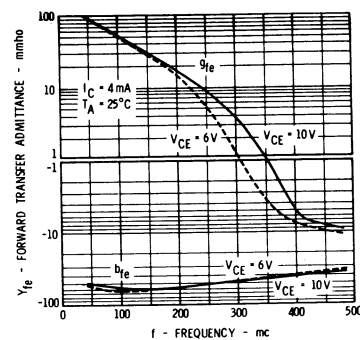
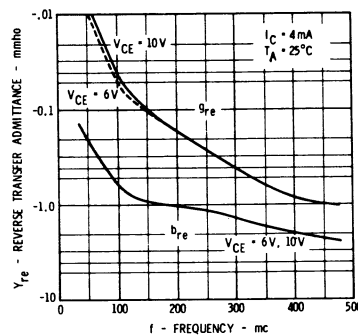
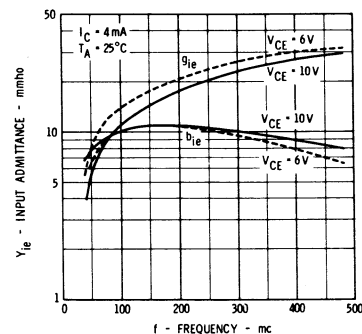
200 mc

vs. COLLECTOR CURRENT



2N3688 • 2N3689 • 2N3690

vs. FREQUENCY



2N3722 • 2N3723

NPN HIGH-VOLTAGE, HIGH-CURRENT SWITCHES

SILICON PLANAR EPITAXIAL TRANSISTORS

- HIGH BREAKDOWN -- 80 VOLT V_{CE0}
- HIGH FREQUENCY -- $f_T = 300$ MHz Min.
- FAST HIGH CURRENT SWITCHING
- LOW $V_{CE(sat)}$ -- 0.75V Max. @ 500 mA
- LOW OUTPUT CAPACITANCE -- 9.0 pF

ABSOLUTE MAXIMUM RATINGS (Note 1)

Maximum Temperatures

Storage Temperature	-65°C to +200°C
Operating Junction Temperature	+200°C Maximum
Lead Temperature (Soldering, 60 sec. time limit)	+300°C Maximum

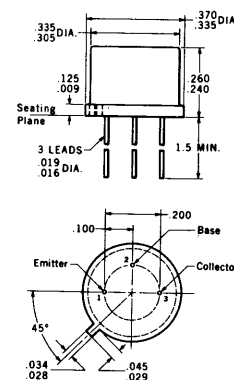
Maximum Power Dissipation

Total Dissipation at 25°C Case Temperature (Notes 2 and 3)	4.0 Watts
at 25°C Ambient Temperature (Notes 2 and 3)	0.8 Watt

Maximum Voltages and Current

		2N3722	2N3723
V_{CBO}	Collector to Base Voltage	80 Volts	100 Volts
V_{CES}	Collector to Emitter Voltage	80 Volts	100 Volts
V_{CEO}	Collector to Emitter Voltage (Note 4)	60 Volts	80 Volts
V_{EBO}	Emitter to Base Voltage	6.0 Volts	6.0 Volts
	Maximum Collector Current (Note 5)	1.0 Amp	1.0 Amp

PHYSICAL DIMENSIONS in accordance with JEDEC (TO-5) outline



NOTES: All dimensions in inches.
Leads are gold-plated lower.
Collector internally connected to case.

ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature unless otherwise noted)

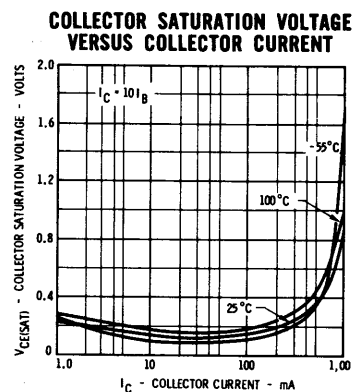
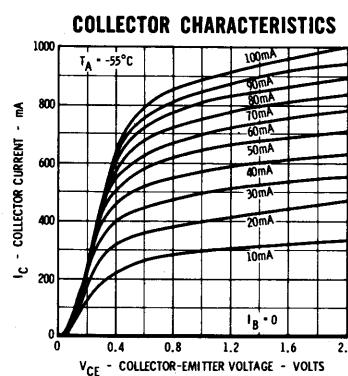
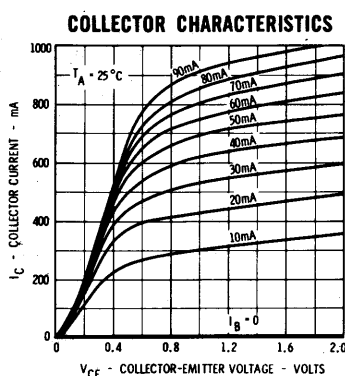
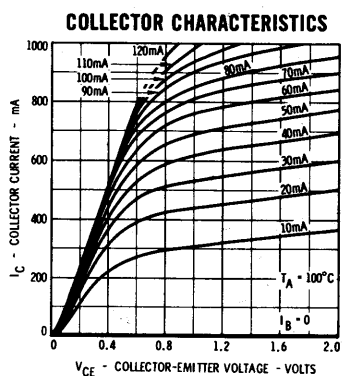
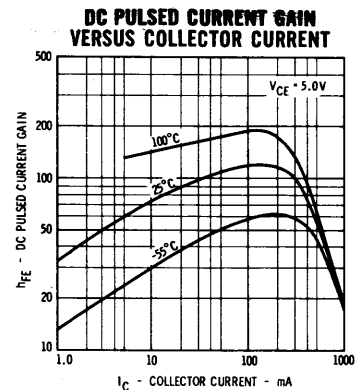
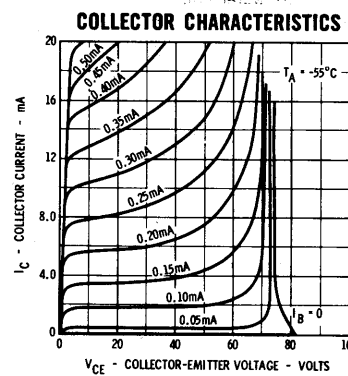
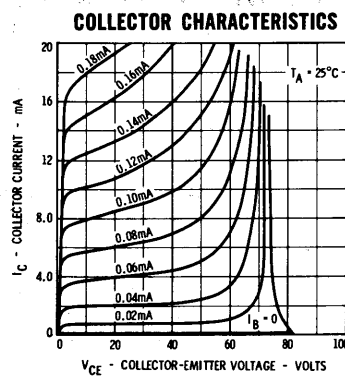
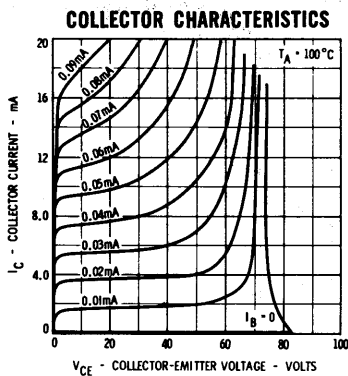
Symbol	Characteristic	2N3722			2N3723			Units	Test Conditions
		Min.	Typ.	Max.	Min.	Typ.	Max.		
$V_{CEO(sust)}$	Collector to Emitter Sustaining Voltage (Notes 4 and 5)	60		80				Volts	$I_C = 10$ mA $I_B = 0$ (pulsed)
$V_{CE(sat)}$	Collector Saturation Voltage (pulsed, see Note 5)	0.35	0.5		0.45	0.75		Volts	$I_C = 500$ mA $I_B = 50$ mA
$V_{CE(sat)}$	Collector Saturation Voltage (pulsed, see Note 5)	0.25	0.37		0.30	0.44		Volts	$I_C = 300$ mA $I_B = 30$ mA
t_{on}	Turn-on Time (Note 6)	20	50		25	70		nsec	$I_C \approx 500$ mA $I_{B1} \approx 50$ mA
t_{off}	Turn-off Time (Note 6)	63	100		70	130		nsec	$I_C \approx 500$ mA $I_{B1} \approx 50$ mA $I_{B2} \approx -50$ mA
h_{fe}	High Frequency Current Gain ($f = 100$ Mc)	3.0	4.0		3.0	4.0			$I_C = 50$ mA $V_{CE} = 10$ V
C_{obo}	Common-Base, Open-Circuit Output Capacitance	5.5	10		5.0	9.0		pf	$I_E = 0$ $V_{CB} = 10$ V
C_{ibo}	Common-Base, Open-Circuit Input Capacitance	50	65		50	65		pf	$I_C = 0$ $V_{BE} = -0.5$ V

FAIRCHILD
SEMICONDUCTOR
A DIVISION OF FAIRCHILD CAMERA AND INSTRUMENT CORPORATION

ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature unless otherwise noted)

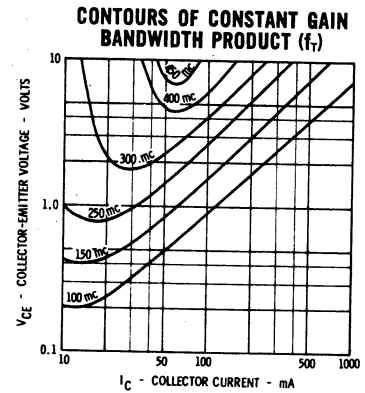
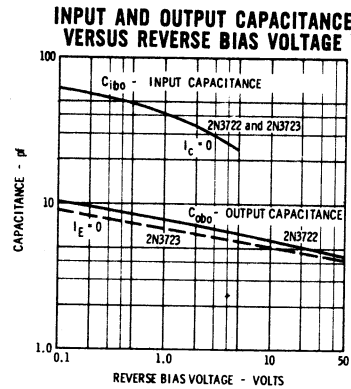
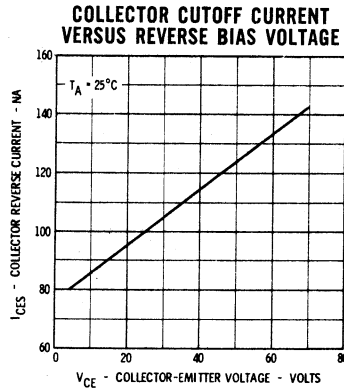
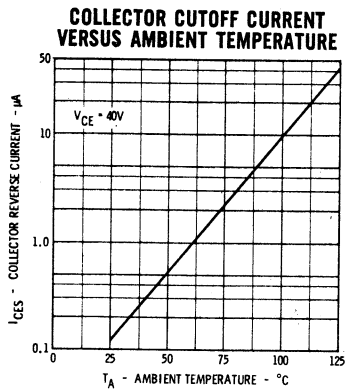
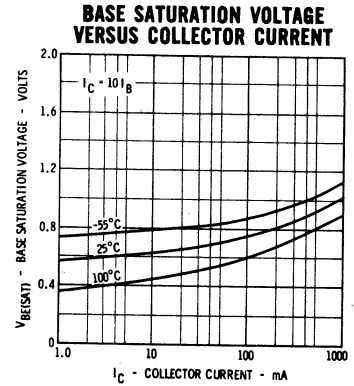
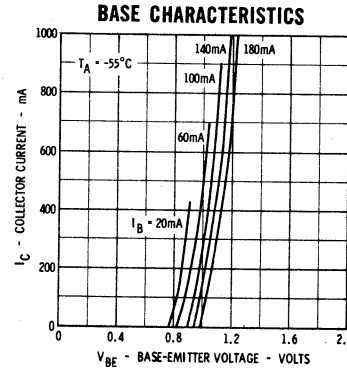
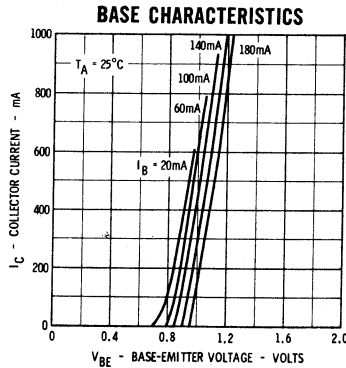
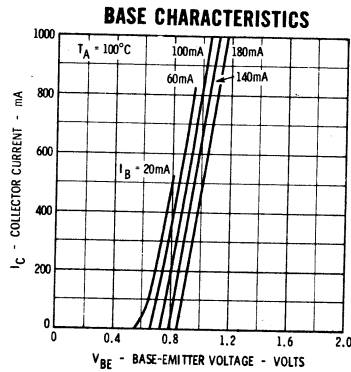
Symbol	Characteristic	2N3722			2N3723			Units	Test Conditions
		Min.	Typ.	Max.	Min.	Typ.	Max.		
h_{FE}	DC Pulse Current Gain (Note 5)	40	70	150	40	70	150		$I_C = 100 \text{ mA}$ $V_{CE} = 1.0 \text{ V}$
h_{FE}	DC Pulse Current Gain (Note 5)	25	45		25	45			$I_C = 10 \text{ mA}$ $V_{CE} = 1.0 \text{ V}$
h_{FE}	DC Pulse Current Gain (Note 5)	20	35		15	30			$I_C = 300 \text{ mA}$ $V_{CE} = 2.0 \text{ V}$
h_{FE}	DC Pulse Current Gain (Note 5)	15	30						$I_C = 500 \text{ mA}$ $V_{CE} = 2.0 \text{ V}$
h_{FE}	DC Pulse Current Gain (Note 5)				15	30			$I_C = 500 \text{ mA}$ $V_{CE} = 3.0 \text{ V}$
h_{FE}	DC Pulse Current Gain (Note 5)	12	25		12	25			$I_C = 800 \text{ mA}$ $V_{CE} = 5.0 \text{ V}$
$h_{FE} (-55^\circ\text{C})$	DC Pulse Current Gain (Note 5)	15	30		15	30			$I_C = 100 \text{ mA}$ $V_{CE} = 1.0 \text{ V}$
$V_{CE}(\text{sat})$	Collector Saturation Voltage (Note 5)	0.15	0.22		0.22	0.28		Volts	$I_C = 100 \text{ mA}$ $I_B = 10 \text{ mA}$
$V_{CE}(\text{sat})$	Collector Saturation Voltage (Note 5)	0.16	0.25		0.16	0.25		Volts	$I_C = 10 \text{ mA}$ $I_B = 1.0 \text{ mA}$
$V_{CE}(\text{sat})$	Collector Saturation Voltage (Note 5)	0.6	2.0					Volts	$I_C = 800 \text{ mA}$ $I_B = 80 \text{ mA}$
$V_{BE}(\text{sat})$	Base Saturation Voltage (Note 5)	0.62	0.75		0.62	0.75		Volts	$I_C = 10 \text{ mA}$ $I_B = 1.0 \text{ mA}$
$V_{BE}(\text{sat})$	Base Saturation Voltage (Note 5)	0.73	0.85		0.73	0.85		Volts	$I_C = 100 \text{ mA}$ $I_B = 10 \text{ mA}$
$V_{BE}(\text{sat})$	Base Saturation Voltage (Note 5)	0.89	1.1		0.89	1.1		Volts	$I_C = 300 \text{ mA}$ $I_B = 30 \text{ mA}$
$V_{BE}(\text{sat})$	Base Saturation Voltage (Note 5)	0.86	0.91	1.2	0.86	0.91	1.2	Volts	$I_C = 500 \text{ mA}$ $I_B = 50 \text{ mA}$
$V_{BE}(\text{sat})$	Base Saturation Voltage (Note 5)		1.0	1.5				Volts	$I_C = 800 \text{ mA}$ $I_B = 80 \text{ mA}$
I_{CES}	Collector Reverse Current		0.1	0.5				μA	$V_{CE} = 40 \text{ V}$ $V_{EB} = 0$
I_{CES}	Collector Reverse Current				0.13	0.5		μA	$V_{CE} = 50 \text{ V}$ $V_{EB} = 0$
$I_{CES} (125^\circ\text{C})$	Collector Reverse Current		40	70				μA	$V_{CE} = 40 \text{ V}$ $V_{EB} = 0$
$I_{CES} (125^\circ\text{C})$	Collector Reverse Current				40	70		μA	$V_{CE} = 50 \text{ V}$ $V_{EB} = 0$
BV_{CBO}	Collector to Base Breakdown Voltage	80		100				Volts	$I_C = 100 \mu\text{A}$ $I_E = 0$
B_{CES}	Collector to Emitter Breakdown Voltage	80		100				Volts	$I_C = 100 \mu\text{A}$ $V_{EB} = 0$
BV_{EBO}	Emitter to Base Breakdown Voltage	6.0		6.0				Volts	$I_C = 0$ $I_E = 100 \mu\text{A}$
$h_{FE} (-55^\circ\text{C})$	DC Pulse Current Gain (Note 5)	20			20				$I_C = 200 \text{ mA}$ $V_{CE} = 2.0 \text{ V}$

TYPICAL ELECTRICAL CHARACTERISTICS
2N3722

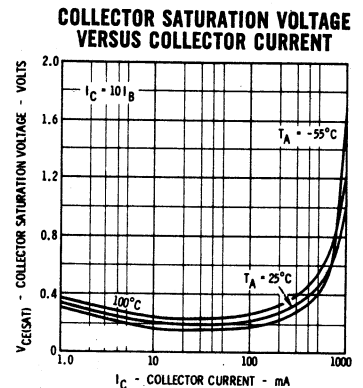
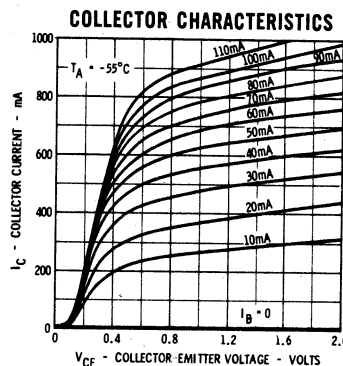
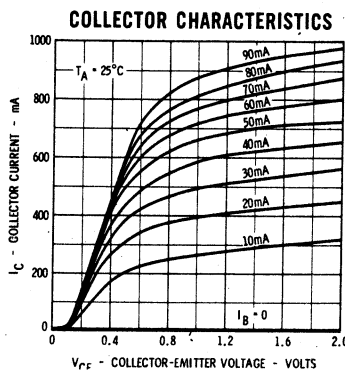
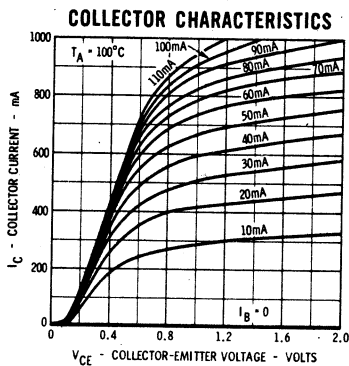
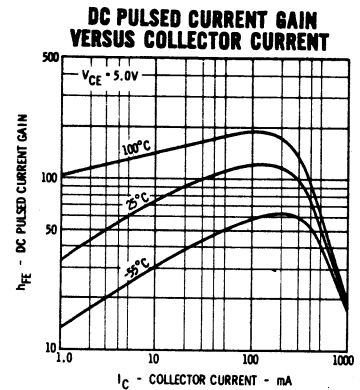
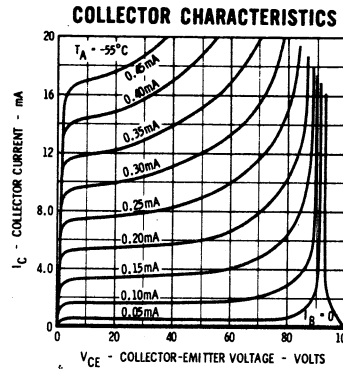
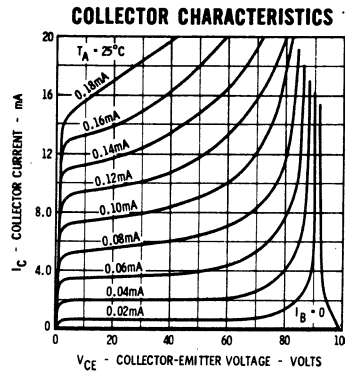
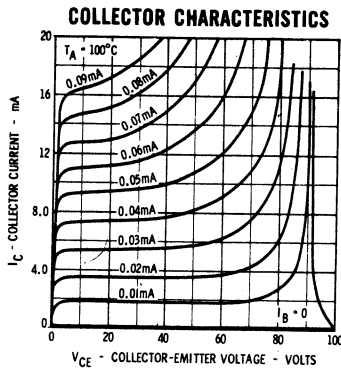


TYPICAL ELECTRICAL CHARACTERISTICS

2N3722 • 2N3723

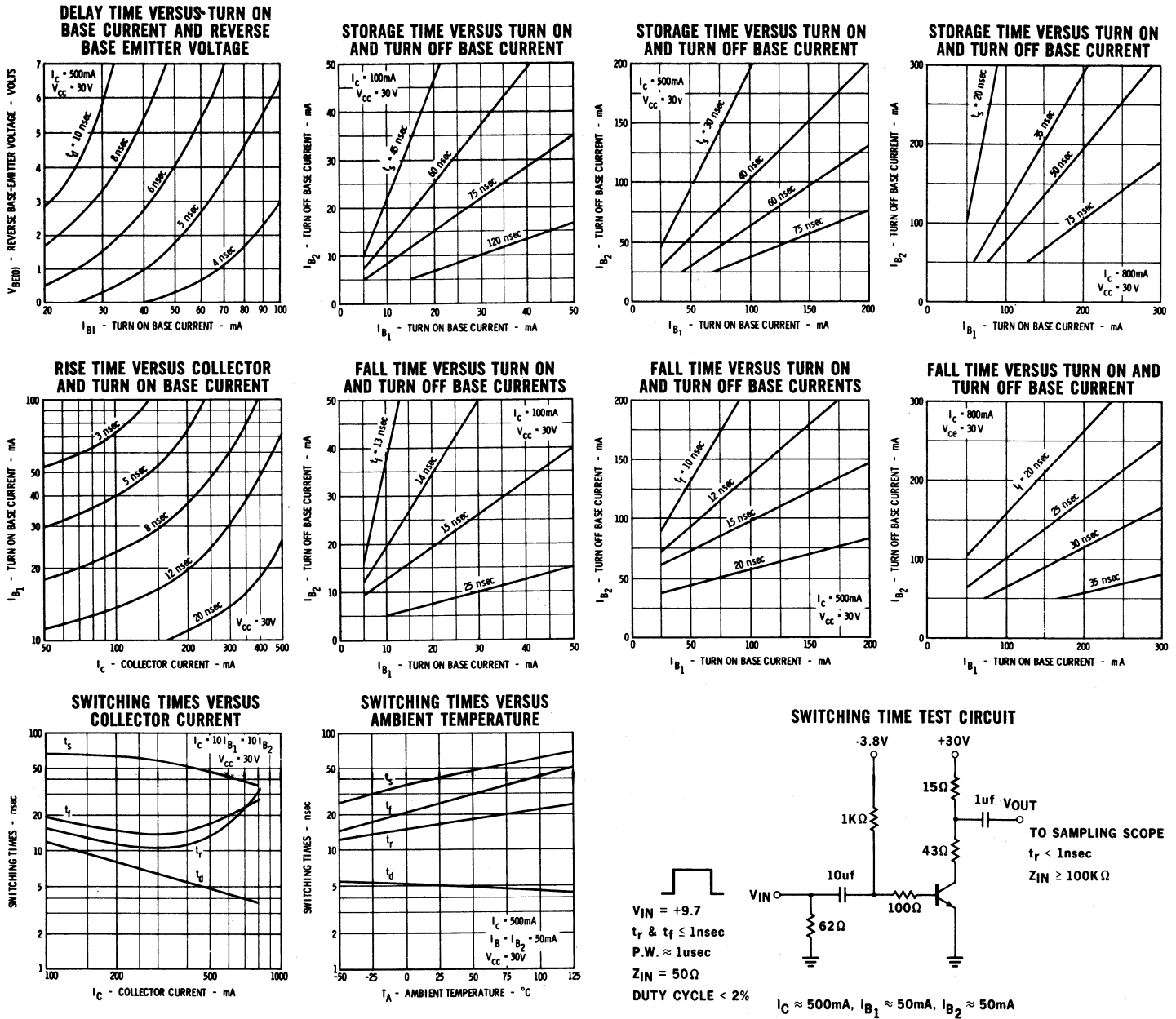


2N3723



TYPICAL ELECTRICAL CHARACTERISTICS

2N3722 • 2N3723



NOTES:

- (1) These ratings are limiting values above which the serviceability of any individual semiconductor may be impaired.
- (2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
- (3) These ratings give a maximum junction temperature of 200°C and junction-to-case thermal resistance of 43.8°C/Watt (derating factor of 22.8 mW/°C). Junction-to-ambient thermal resistance of 219°C/Watt (derating factor of 4.56 mW/°C).
- (4) Rating refers to a high-current point where collector-to-emitter voltage is lowest.
- (5) Pulse Conditions: length = 300 μsec; duty cycle = 1%.
- (6) See switching circuit for exact values of I_C , I_{B1} , and I_{B2} .

2N3728 • 2N3729

NPN HIGH PERFORMANCE DIFFERENTIAL AMPLIFIERS

DIFFUSED SILICON PLANAR* EPITAXIAL TRANSISTORS

- **BETA RATIO** -- $\frac{h_{FE1}}{h_{FE2}} = 0.9-1.0$ FROM 100 μ A to 1.0 mA
 $\frac{h_{FE1}}{h_{FE2}} = 0.8-1.0$ FROM 100 μ A to 1.0 mA, -55°C to $+125^{\circ}\text{C}$
- **V_{BE} MATCHING** -- $|V_{BE1} - V_{BE2}| = 3.0$ mV (MAX) FROM 100 μ A to 1.0 mA
- **V_{BE} TRACKING** -- $\Delta V_{BE} = 10$ μ V/ $^{\circ}\text{C}$ (MAX) FROM 100 μ A to 1.0 mA, -55°C to $+125^{\circ}\text{C}$
- **MEDIUM VOLTAGE** -- $V_{CEO} = 30$ V (MIN)

ABSOLUTE MAXIMUM RATINGS (Note 1)

Maximum Temperatures

Storage Temperature

-65°C to $+200^{\circ}\text{C}$

Operating Junction Temperature

200°C Maximum

Lead Temperature (Soldering, 60 second time limit)

300°C Maximum

Maximum Power Dissipation

Total Dissipation at 25°C Case Temperature (Notes 2 and 3)

One Side

Both Sides

at 100°C Case Temperature (Notes 2 and 3)

1.0 Watt

1.6 Watt

at 25°C Ambient Temperature (Notes 2 and 3)

0.57 Watt

0.91 Watt

Maximum Voltages and Current

V_{CBO} Collector to Base Voltage

60 Volts

V_{CEO} Collector to Emitter Voltage (Note 4)

30 Volts

V_{EBO} Emitter to Base Voltage

5.0 Volts

I_C Collector Current

500 mA

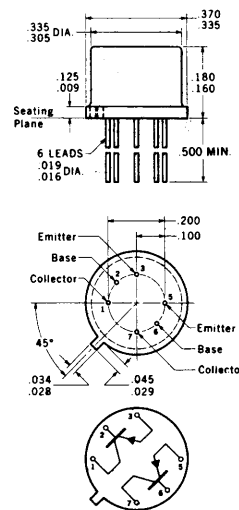
$V_{C1 C2}$ Collector₁ to Collector₂ Voltage

± 200 Volts

Voltage rating any lead to case

± 200 Volts

PHYSICAL DIMENSIONS



NOTES: All dimensions in inches.
Leads are gold-plated nickel.
Package weight is 1.00 grams.

MATCHING CHARACTERISTICS (25°C Free Air Temperature unless otherwise noted)

SYMBOL	CHARACTERISTICS	2N3728		2N3729		UNITS	TEST CONDITIONS
		MIN.	MAX.	MIN.	MAX.		
$\frac{h_{FE1}}{h_{FE2}}$	DC Current Gain Ratio (Note 5)	0.8	1.0	0.9	1.0		$I_C = 100 \mu\text{A}$ to 1.0 mA $V_{CE} = 5.0$ V
$\frac{h_{FE1}}{h_{FE2}}$	DC Current Gain Ratio (Note 5)			0.8	1.0		$I_C = 100 \mu\text{A}$ to 1.0 mA $V_{CE} = 5.0$ V
$ V_{BE1} - V_{BE2} $	Base-Emitter Voltage Differential		5.0		3.0	mV	$I_C = 100 \mu\text{A}$ to 1.0 mA $V_{CE} = 5.0$ V
$ \Delta(V_{BE1} - V_{BE2}) $	Base-Emitter Voltage Differential Change ($T_A = -55^{\circ}\text{C}$ to 25°C)		1.6 (20 $\mu\text{V}/^{\circ}\text{C}$)		0.8 (10 $\mu\text{V}/^{\circ}\text{C}$)	mV	$I_C = 100 \mu\text{A}$ to 1.0 mA $V_{CE} = 5.0$ V
$ \Delta(V_{BE1} - V_{BE2}) $	Base-Emitter Voltage Differential Change ($T_A = 25^{\circ}\text{C}$ to 125°C)		2.0 (20 $\mu\text{V}/^{\circ}\text{C}$)		1.0 (10 $\mu\text{V}/^{\circ}\text{C}$)	mV	$I_C = 100 \mu\text{A}$ to 1.0 mA $V_{CE} = 5.0$ V

*Planar is a patented Fairchild process.

NOTES:

- (1) These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
- (2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
- (3) These ratings give a maximum junction temperature of 200°C and junction to ambient thermal resistance of $384^{\circ}\text{C}/\text{Watt}$ (derating factor of $2.57 \text{ mW}/^{\circ}\text{C}$) for one side; $318^{\circ}\text{C}/\text{Watt}$ (derating factor of $3.14 \text{ mW}/^{\circ}\text{C}$) for both sides. Junction to case thermal resistance of $175^{\circ}\text{C}/\text{Watt}$ (derating factor of $5.71 \text{ mW}/^{\circ}\text{C}$) for one side; $109^{\circ}\text{C}/\text{Watt}$ (derating factor of $9.15 \text{ mW}/^{\circ}\text{C}$) for both sides.
- (4) Rating refers to a high-current point where collector to emitter voltage is lowest.
- (5) Lowest of two h_{FE} readings is taken as h_{FE1} for purposes of this ratio.
- (6) Pulse Conditions: length = 300 μs ; duty cycle = 1%.

FAIRCHILD
SEMICONDUCTOR
A DIVISION OF FAIRCHILD CAMERA AND INSTRUMENT CORPORATION

313 FAIRCHILD DRIVE, MOUNTAIN VIEW, CALIFORNIA, (415) 962-5011, TWX: 910-379-6435

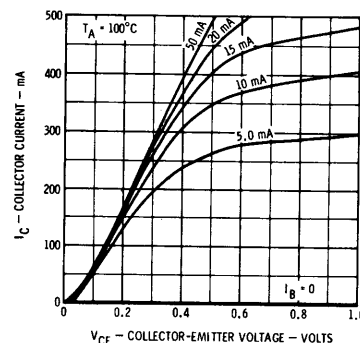
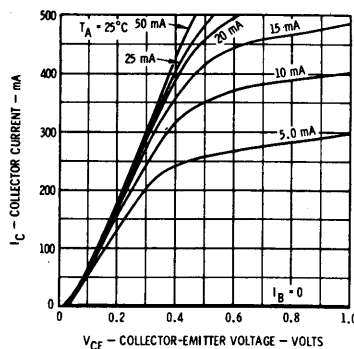
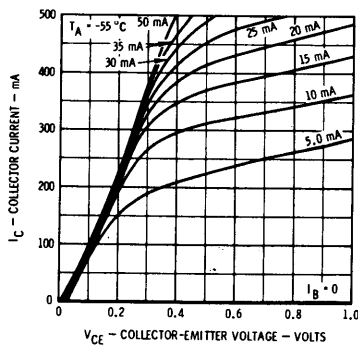
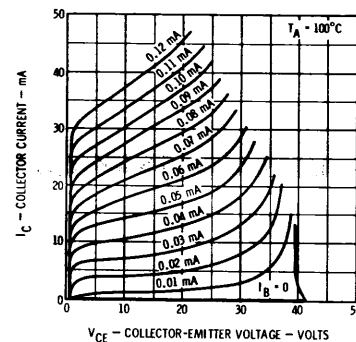
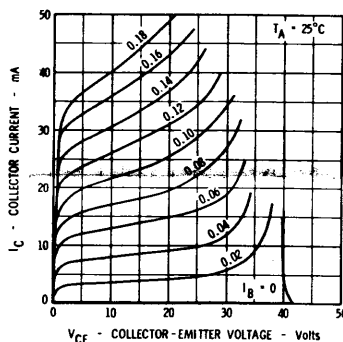
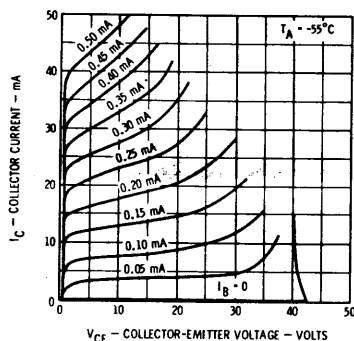
FAIRCHILD TRANSISTORS 2N3728 • 2N3729

ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature unless otherwise noted)

SYMBOL	CHARACTERISTICS	MIN.	MAX.	UNITS	TEST CONDITIONS
h_{FE}	DC Current Gain	30			$I_C = 0.1 \text{ mA}$ $V_{CE} = 5.0 \text{ V}$
h_{FE}	DC Current Gain	45	180		$I_C = 1.0 \text{ mA}$ $V_{CE} = 5.0 \text{ V}$
h_{FE}	DC Current Gain (Note 6)	80	280		$I_C = 150 \text{ mA}$ $V_{CE} = 5.0 \text{ V}$
BV_{CBO}	Collector to Base Breakdown Voltage	60			$I_C = 10 \mu\text{A}$ $I_E = 0$
BV_{EBO}	Emitter to Base Breakdown Voltage	5.0			$I_C = 0$ $I_E = 10 \mu\text{A}$
$V_{CEO}(\text{sust})$	Collector to Emitter Sustaining Voltage (Notes 4 and 6)	30			$I_C = 10 \text{ mA}$ $I_B = 0$
$V_{CE}(\text{sat})$	Collector Saturation Voltage (Note 6)		0.22	Volts	$I_C = 150 \text{ mA}$ $I_B = 15 \text{ mA}$
$V_{BE}(\text{sat})$	Base Saturation Voltage (Note 6)		1.1	Volts	$I_C = 150 \text{ mA}$ $I_B = 15 \text{ mA}$
I_{CBO}	Collector Cutoff Current		10	nA	$I_E = 0$ $V_{CB} = 50 \text{ V}$
$I_{CBO}(150^\circ\text{C})$	Collector Cutoff Current		10	μA	$I_E = 0$ $V_{CB} = 50 \text{ V}$
I_{EBO}	Emitter Cutoff Current		10	nA	$I_C = 0$ $V_{EB} = 3.0 \text{ V}$
h_{fe}	High Frequency Current Gain	4.0			$I_C = 1.0 \text{ mA}$, $V_{CE} = 10 \text{ V}$, $f = 20 \text{ MHz}$
h_{fe}	High Frequency Current Gain	2.5	6.0		$I_C = 50 \text{ mA}$, $V_{CE} = 10 \text{ V}$, $f = 100 \text{ MHz}$
C_{obo}	Common-Base, Open-Circuit Output Capacitance		8.0	pF	$I_E = 0$, $V_{CB} = 10 \text{ V}$, $f = 140 \text{ kHz}$
C_{ibo}	Common-Base, Open-Circuit Input Capacitance		20	pF	$I_C = 0$, $V_{EB} = 2.0 \text{ V}$, $f = 140 \text{ kHz}$
h_{ie}	Input Impedance	1.2	4.0	k Ω	$I_C = 1.0 \text{ mA}$, $V_{CE} = 10 \text{ V}$, $f = 1.0 \text{ kHz}$
h_{re}	Reverse Voltage Feedback Ratio		200	$\times 10^{-6}$	$I_C = 1.0 \text{ mA}$, $V_{CE} = 10 \text{ V}$, $f = 1.0 \text{ kHz}$
h_{oe}	Output Conductance		10		$I_C = 1.0 \text{ mA}$, $V_{CE} = 10 \text{ V}$, $f = 1.0 \text{ kHz}$
h_{fe}	Forward Current Transfer Ratio	50	200		$I_C = 1.0 \text{ mA}$, $V_{CE} = 10 \text{ V}$, $f = 1.0 \text{ kHz}$
NF	Wideband Noise Figure ($f = 15.7 \text{ kHz}$)		7.0	dB	$I_C = 0.1 \text{ mA}$ $V_{CE} = 5.0 \text{ V}$ 3 dB pts @ 25 Hz and 10 kHz $R_S = 1.0 \text{ k}\Omega$

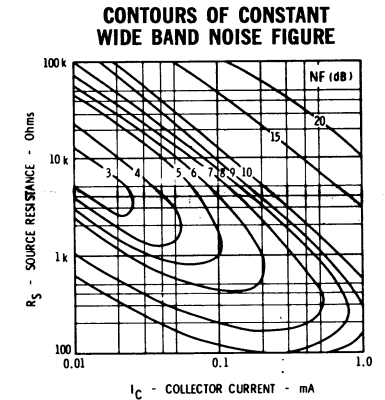
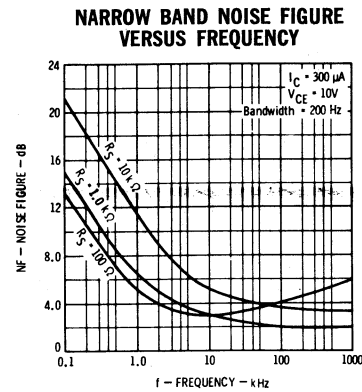
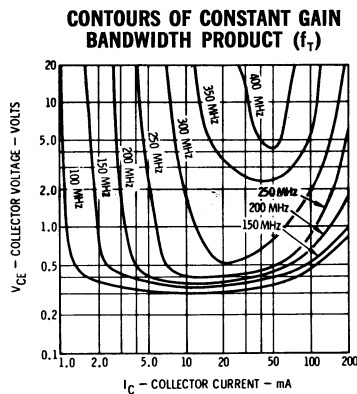
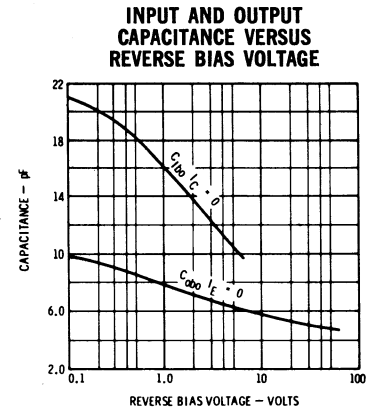
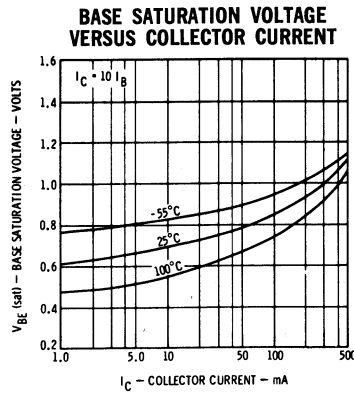
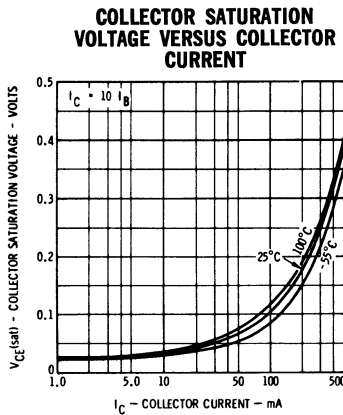
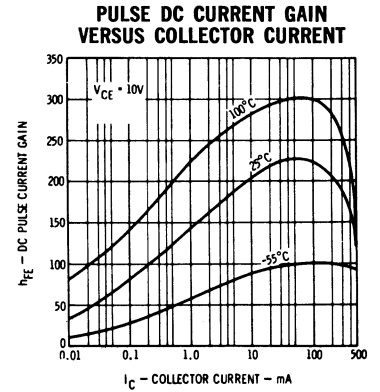
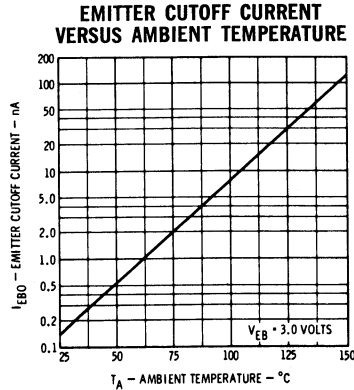
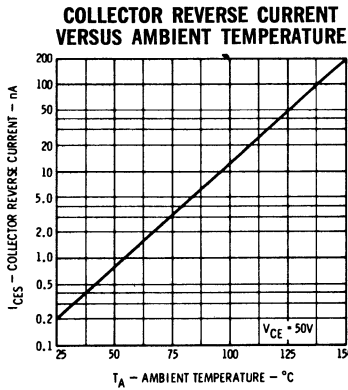
TYPICAL COLLECTOR CHARACTERISTICS*

Active Region

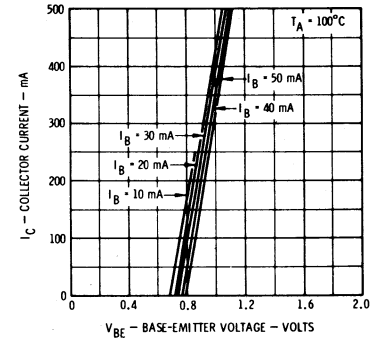
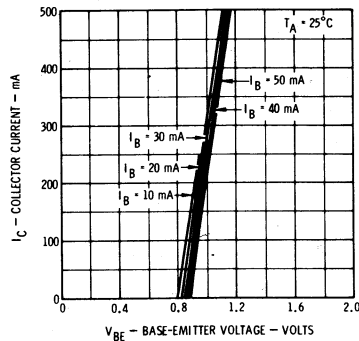
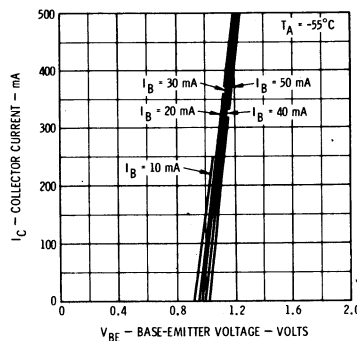


* Single family characteristics on Transistor Curve Tracer.

TYPICAL ELECTRICAL CHARACTERISTICS



TYPICAL BASE CHARACTERISTICS



2N3923

NPN HIGH-VOLTAGE AMPLIFIER

DIFFUSED SILICON PLANAR TRANSISTOR

GENERAL DESCRIPTION - The 2N3923 is an NPN silicon PLANAR transistor designed primarily for use as a high-voltage output device where low collector base capacitance is required. The device features a maximum C_{obo} of 3.5 pf together with a minimum V_{CEO} of 150 volts and a minimum f_T of 40 Mc. The TO-5 package permits operation to 200°C junction temperature and a power rating of 3 watts.

ABSOLUTE MAXIMUM RATINGS [Note 1]

Maximum Temperatures

Storage Temperature	-65°C to +200°C
Operating Junction Temperature	-65°C to +200°C
Lead Temperature (Soldering, 60 sec time limit)	+300°C Maximum

Maximum Power Dissipation

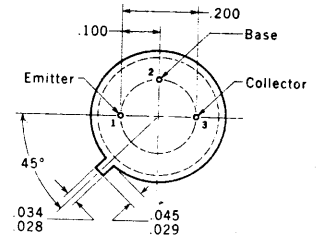
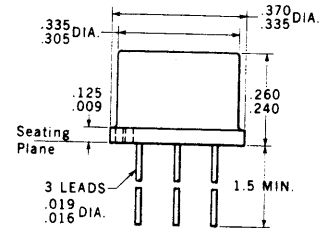
Total Dissipation at 25°C Case Temperature	(Notes 2 and 3)	3.0 Watts
at 25°C Ambient Temperature	(Notes 2 and 3)	0.8 Watt

Maximum Voltages and Current

V_{CBO}	Collector to Base Voltage	150 Volts
V_{CEO}	Collector to Emitter Voltage (Note 4)	150 Volts
V_{EBO}	Emitter to Base Voltage	6.0 Volts
I_C	Collector Current	100 mA

PHYSICAL DIMENSIONS

in accordance with
JEDEC (TO-5) outline



NOTES: All dimensions in inches
Leads are gold plated kovar
Collector internally connected to case

ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature unless otherwise noted)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Conditions
h_{FE}	DC Pulse Current Gain (Note 5)	30	100	120		$I_C = 25 \text{ mA}$, $V_{CE} = 10 \text{ V}$
$h_{FE}(-55^\circ\text{C})$	DC Pulse Current Gain (Note 5)	15	40			$I_C = 25 \text{ mA}$, $V_{CE} = 10 \text{ V}$
h_{FE}	DC Current Gain	15	62			$I_C = 100 \mu\text{A}$, $V_{CE} = 10 \text{ V}$
$V_{CEO}(\text{sust})$	Collector to Emitter Sustaining Voltage (Notes 4 and 5)	150			Volts	$I_C = 10 \text{ mA}$, $I_B = 0$ (pulsed)
BV_{CBO}	Collector to Base Breakdown Voltage	150			Volts	$I_C = 100 \mu\text{A}$, $I_E = 0$
BV_{EBO}	Emitter to Base Breakdown Voltage	6.0			Volts	$I_E = 100 \mu\text{A}$, $I_C = 0$
$V_{BE}(\text{sat})$	Base Saturation Voltage		0.77	0.9	Volts	$I_C = 25 \text{ mA}$, $I_B = 2.5 \text{ mA}$
$V_{CE}(\text{sat})$	Collector Saturation Voltage		0.3	1.0	Volts	$I_C = 25 \text{ mA}$, $I_B = 2.5 \text{ mA}$

NOTES:

- These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
- These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
- These ratings give a maximum junction temperature of 200°C and junction-to-case thermal resistance of 58°C/Watt (derating factor of 17.2 mW/°C); junction-to-ambient thermal resistance of 219°C/Watt (derating factor of 4.56 mW/°C).
- This rating refers to a high-current point where collector-to-emitter voltage is lowest.
- Pulse Conditions: length = 300 μsec ; duty cycle = 1%.

FAIRCHILD
SEMICONDUCTOR
A DIVISION OF FAIRCHILD CAMERA AND INSTRUMENT CORPORATION

313 FAIRCHILD DRIVE, MOUNTAIN VIEW, CALIFORNIA, (415) 962-5011, TWX: 910-379-6435

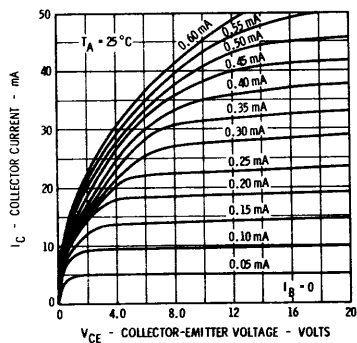
FAIRCHILD TRANSISTOR 2N3923

ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature unless otherwise noted)

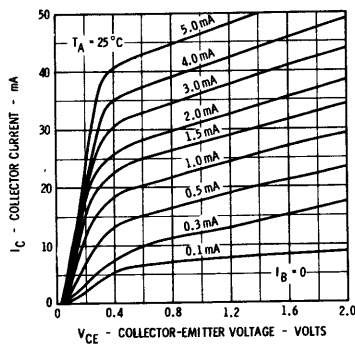
Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Conditions	
I_{CBO}	Collector Cutoff Current		0.1	10	nA	$I_E = 0$	$V_{CB} = 100 \text{ V}$
$I_{CBO}(150^\circ\text{C})$	Collector Cutoff Current		0.5	10	μA	$I_E = 0$	$V_{CB} = 100 \text{ V}$
I_{EBO}	Emitter Cutoff Current		0.005	50	nA	$I_C = 0$	$V_{EB} = 4.0 \text{ V}$
h_{fe}	High Frequency Current Gain ($f = 20 \text{ Mc}$)	2.0	4.3			$I_C = 10 \text{ mA}$	$V_{CE} = 10 \text{ V}$
h_{fe}	Small Signal Current Gain ($f = 1.0 \text{ Kc}$)	20				$I_C = 25 \text{ mA}$	$V_{CE} = 10 \text{ V}$
C_{obo}	Common Base Open Circuit Output Capacitance		2.6	3.5	pf	$I_E = 0$	$V_{CB} = 20 \text{ V}$
C_{ibo}	Common Base Open Circuit Input Capacitance		17	25	pf	$I_C = 0$	$V_{EB} = 0.5 \text{ V}$
$R_e(h_{ie})$	Real Part of Input Impedance ($f = 300 \text{ Mc}$)			50	Ohms	$I_C = 10 \text{ mA}$	$V_{CE} = 10 \text{ V}$

TYPICAL ELECTRICAL CHARACTERISTICS

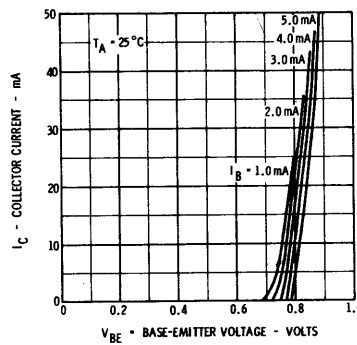
COLLECTOR CHARACTERISTICS*



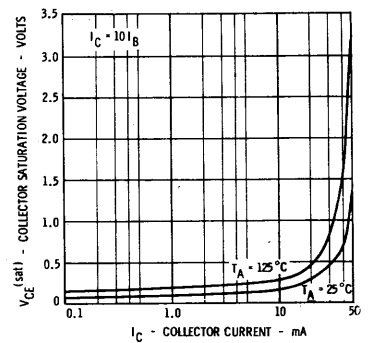
COLLECTOR CHARACTERISTICS*



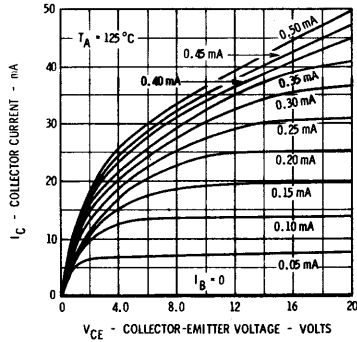
BASE CHARACTERISTICS*



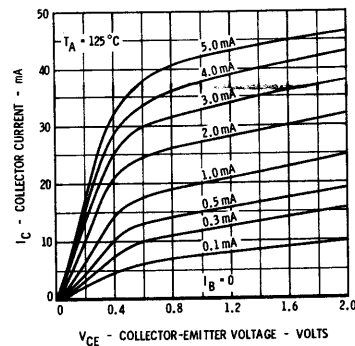
COLLECTOR SATURATION VOLTAGE VERSUS COLLECTOR CURRENT



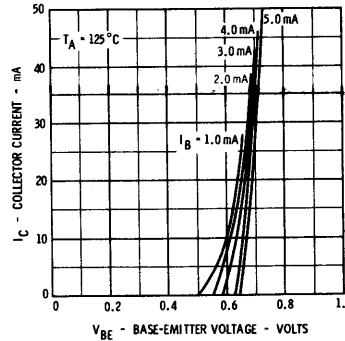
COLLECTOR CHARACTERISTICS*



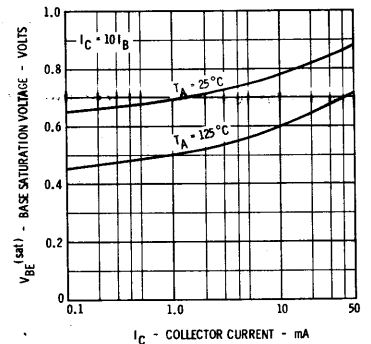
COLLECTOR CHARACTERISTICS*



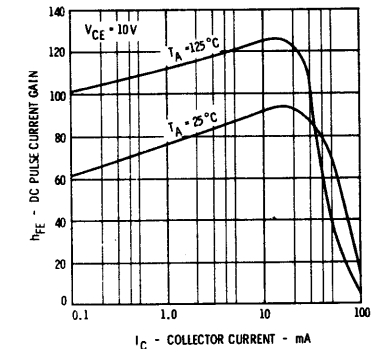
BASE CHARACTERISTICS*



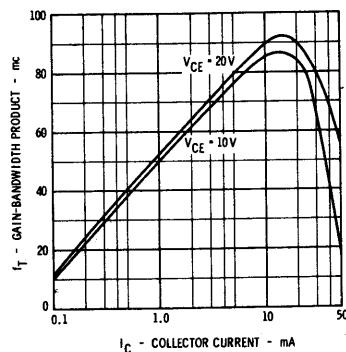
BASE SATURATION VOLTAGE VERSUS COLLECTOR CURRENT



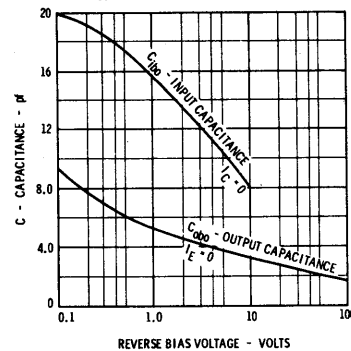
DC PULSE CURRENT GAIN VERSUS COLLECTOR CURRENT



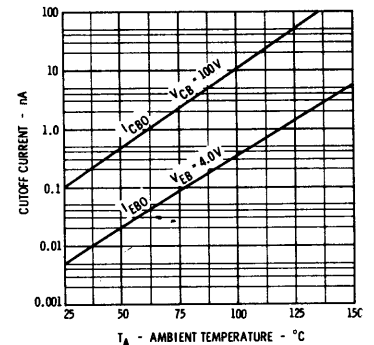
GAIN-BANDWIDTH PRODUCT VERSUS COLLECTOR CURRENT



INPUT AND OUTPUT CAPACITANCE VERSUS REVERSE BIAS VOLTAGE



COLLECTOR & EMITTER CUTOFF CURRENTS VERSUS AMBIENT TEMPERATURE



* Single family characteristics on Transistor Curve Tracer

2N3930 • 2N3931 • 2N4357 • 2N4358

PNP HIGH VOLTAGE AMPLIFIER DIFFUSED SILICON PLANAR* II TRANSISTORS

FEATURES

- HIGH VOLTAGE -- 240 VOLT V_{CE0}
- HIGH BETA -- 80-300 @ 10 mA
- LOW NOISE -- 3 dB @ 1.0 kHz
- EXCELLENT BETA LINEARITY from 10 μ A to 50 mA

ABSOLUTE MAXIMUM RATINGS [Note 1]

Maximum Temperatures

Storage Temperature	-65°C to +200°C
Operating Junction Temperature	+200°C
Lead Temperature (Soldering, 60 second time limit)	+300°C

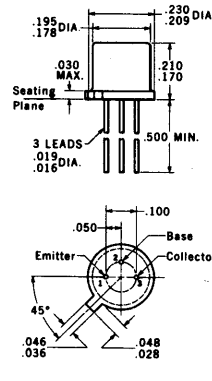
Maximum Power Dissipation [Notes 2 and 3]

Total Dissipation at 25°C Case Temperature	2N3930 1.4 Watts	2N3931 2.5 Watts
at 25°C Ambient Temperature	2N4357 0.4 Watt	2N4358 0.7 Watt

Maximum Voltages

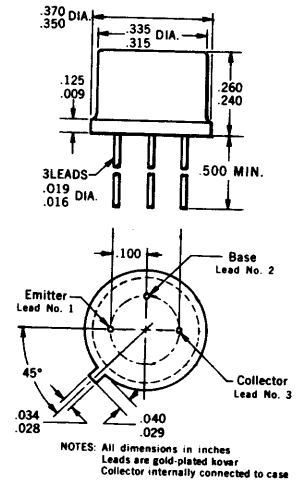
V_{CBO}	Collector to Base Voltage	2N3930 -180 Volts	2N3931 -240 Volts
V_{CEO}	Collector to Emitter to Voltage [Note 4]	2N4357 -180 Volts	2N4358 -240 Volts
V_{EBO}	Emitter to Base Voltage	-6.0 Volts	-6.0 Volts

PHYSICAL DIMENSIONS in accordance with JEDEC (TO-18) outline



2N3930 • 2N4357

PHYSICAL DIMENSIONS in accordance with JEDEC (TO-39) outline



2N3931 • 2N4358

ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature Unless Otherwise Noted)

SYMBOL	CHARACTERISTIC	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
BV_{CBO}	Collector to Base Breakdown Voltage	2N3930 -180			Volts	$I_C = 10 \mu A$ $I_E = 0$
BV_{CBO}	Collector to Base Breakdown Voltage	2N3931 -240			Volts	$I_C = 10 \mu A$ $I_E = 0$
$V_{CEO(sust)}$	Collector to Emitter Sustaining Voltage	2N4357 -180			Volts	$I_C = 2.0 mA$ $I_B = 0$
$V_{CEO(sust)}$	Collector to Emitter Sustaining Voltage	2N4358 -240			Volts	$I_C = 2.0 mA$ $I_B = 0$
h_{FE}	DC Current Gain	60	110			$I_C = 10 \mu A$ $V_{CE} = -10 V$
h_{FE}	DC Current Gain	80	170			$I_C = 1.0 mA$ $V_{CE} = -10 V$
h_{FE}	DC Pulse Current Gain [Note 5]	80	200	300		$I_C = 10 mA$ $V_{CE} = -10 V$
$h_{FE} (-55^\circ C)$	DC Current Gain	15	50			$I_C = 10 \mu A$ $V_{CE} = -10 V$
$h_{FE} (-55^\circ C)$	DC Current Gain	30	105			$I_C = 100 \mu A$ $V_{CE} = -10 V$
$V_{CE(sat)}$	Collector Saturation Voltage	2N3930 -0.1	-0.25		Volts	$I_C = 10 mA$ $I_B = 1.0 mA$
$V_{CE(sat)}$	Collector Saturation Voltage	2N3931 -0.2	-0.5		Volts	$I_C = 10 mA$ $I_B = 1.0 mA$
		2N4357				
		2N4358				

* Planar is a patented Fairchild process.

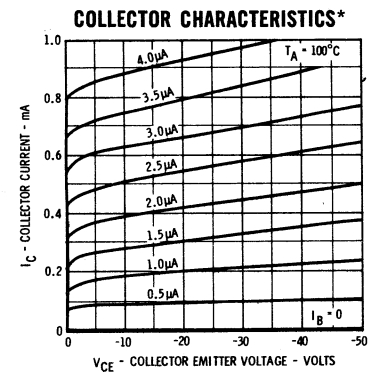
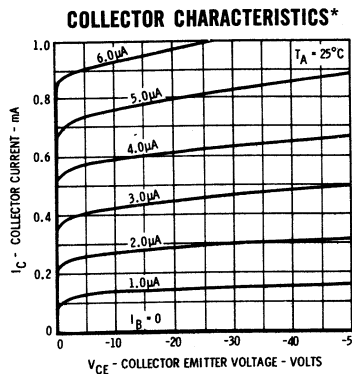
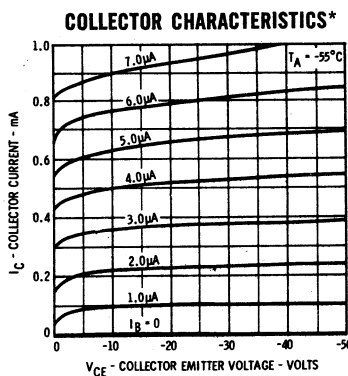
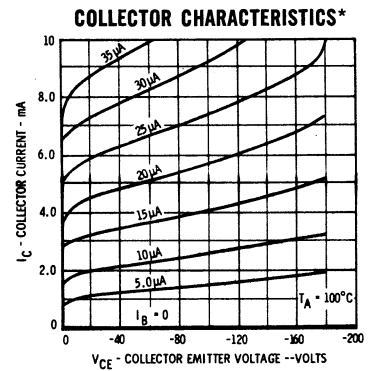
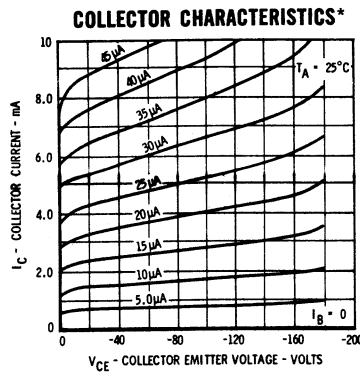
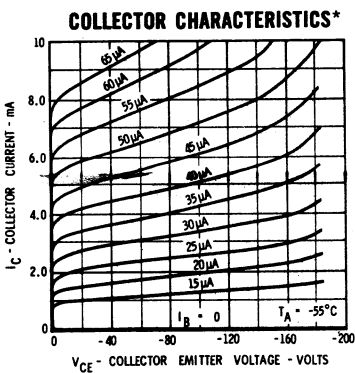
FAIRCHILD
SEMICONDUCTOR
A DIVISION OF FAIRCHILD CAMERA AND INSTRUMENT CORPORATION

FAIRCHILD TRANSISTORS 2N3930 • 2N3931 • 2N4357 • 2N4358

ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature Unless Otherwise Noted)

SYMBOL	CHARACTERISTIC	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
$V_{BE(sat)}$	Base Saturation Voltage		0.74	0.9	Volts	$I_C = 10 \text{ mA}$ $I_B = 1.0 \text{ mA}$
BV_{EBO}	Emitter to Base Breakdown Voltage	-6.0			Volts	$I_E = 10 \mu\text{A}$ $I_C = 0$
I_{EBO}	Emitter Cutoff Current		0.2	10	nA	$I_C = 0$ $V_{EB} = -4.0 \text{ V}$
I_{CBO}	Collector Reverse Current		0.2	10	nA	$I_E = 0$ $V_{CB} = -100 \text{ V}$
I_{CBO}	Collector Reverse Current		0.5	20	nA	$I_E = 0$ $V_{CB} = -200 \text{ V}$
$I_{CBO} (150^\circ\text{C})$	Collector Reverse Current		0.03	10	μA	$I_E = 0$ $V_{CB} = -100 \text{ V}$
$I_{CBO} (150^\circ\text{C})$	Collector Reverse Current		0.07	20	μA	$I_E = 0$ $V_{CB} = -200 \text{ V}$
C_{obo}	Open Circuit, Output Capacitance ($f = 1.0 \text{ MHz}$)		5.0	7.0	pF	$I_E = 0$ $V_{CB} = -5.0 \text{ V}$
C_{ibo}	Open Circuit, Input Capacitance ($f = 1.0 \text{ MHz}$)		20	25	pF	$I_C = 0$ $V_{EB} = -0.5 \text{ V}$
h_{fe}	High Frequency Current Gain ($f = 20 \text{ MHz}$)	2.0	3.0	8.0		$I_C = 1.0 \text{ mA}$ $V_{CE} = -10 \text{ V}$
NF	Narrow Band Noise Figure ($f = 10 \text{ kHz}$)		1.0	3.0	dB	$I_C = 10 \mu\text{A}$ $V_{CE} = -5.0 \text{ V}$ $R_s = 10 \text{ k}\Omega$ $BW = 1.5 \text{ kHz}$
NF	Narrow Band Noise Figure ($f = 1.0 \text{ kHz}$)		1.0	3.0	dB	$I_C = 10 \mu\text{A}$ $V_{CE} = -5.0 \text{ V}$ $R_s = 10 \text{ k}\Omega$ $BW = 150 \text{ Hz}$
NF	Narrow Band Noise Figure ($f = 100 \text{ Hz}$)		2.0	10	dB	$I_C = 10 \mu\text{A}$ $V_{CE} = -5.0 \text{ V}$ $R_s = 10 \text{ k}\Omega$ $BW = 15 \text{ Hz}$

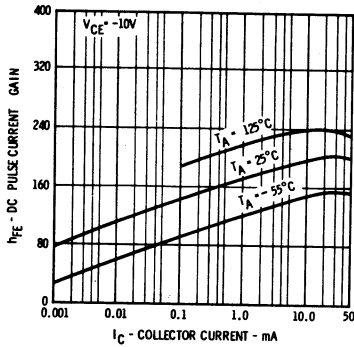
TYPICAL ELECTRICAL CHARACTERISTICS



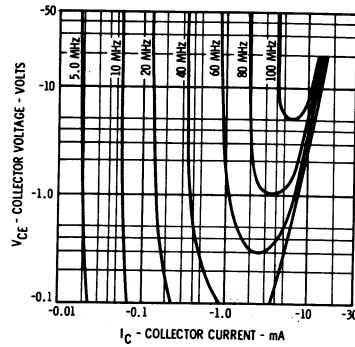
* Single family characteristic on Transistor Curve Tracer.

TYPICAL ELECTRICAL CHARACTERISTICS

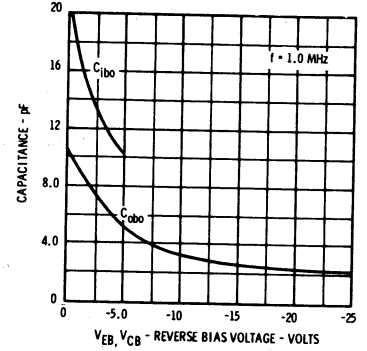
DC PULSE CURRENT GAIN
VERSUS COLLECTOR CURRENT



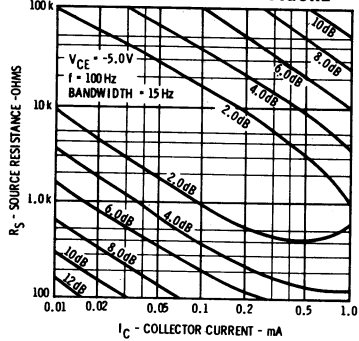
CONTOURS OF CONSTANT GAIN
BANDWIDTH PRODUCT (f_t)



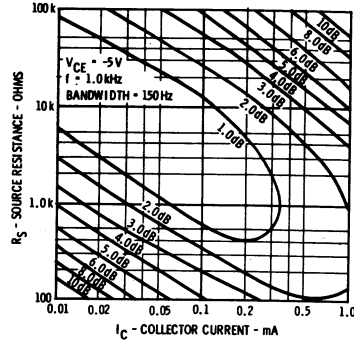
INPUT AND OUTPUT
CAPACITANCE VERSUS REVERSE
BIAS VOLTAGE



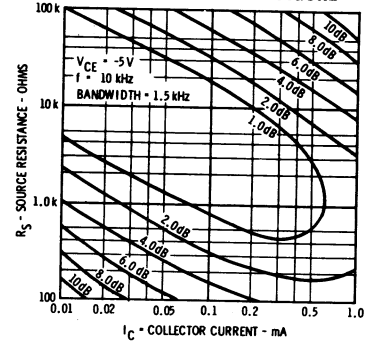
CONTOURS OF CONSTANT
NARROW BAND NOISE FIGURE



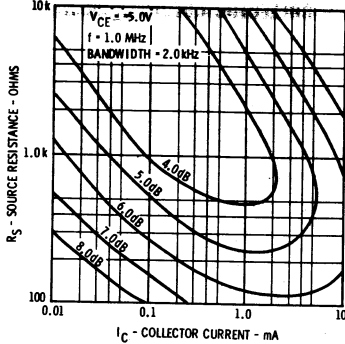
CONTOURS OF CONSTANT
NARROW BAND NOISE FIGURE



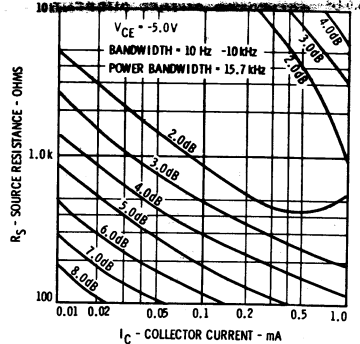
CONTOURS OF CONSTANT
NARROW BAND NOISE FIGURE



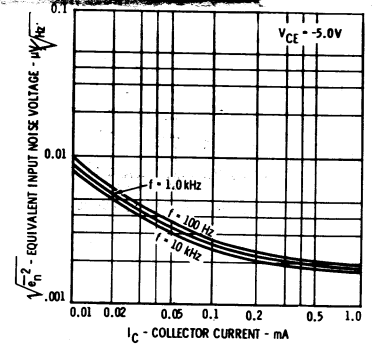
CONTOURS OF CONSTANT
NARROW BAND NOISE FIGURE



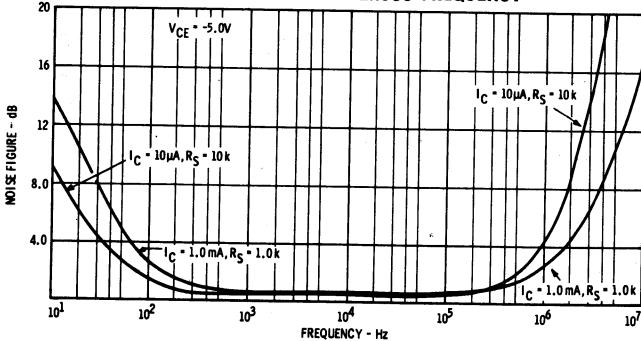
CONTOURS OF CONSTANT
WIDE BAND NOISE FIGURE



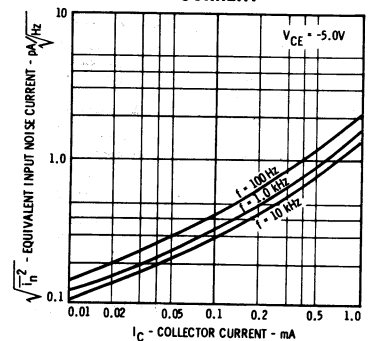
EQUIVALENT INPUT NOISE
VOLTAGE VERSUS COLLECTOR
CURRENT



SPOT NOISE FIGURE VERSUS FREQUENCY



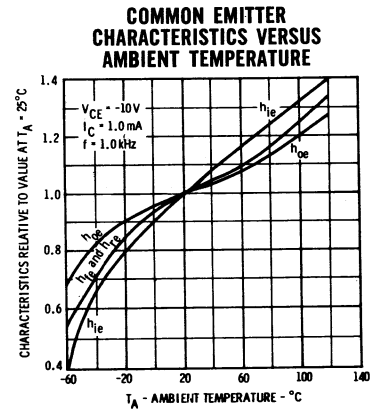
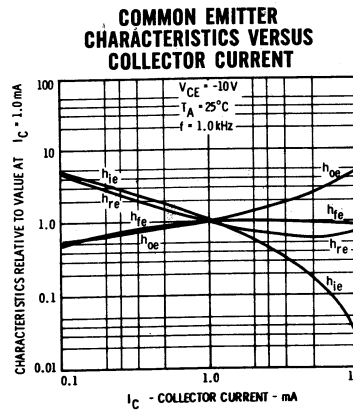
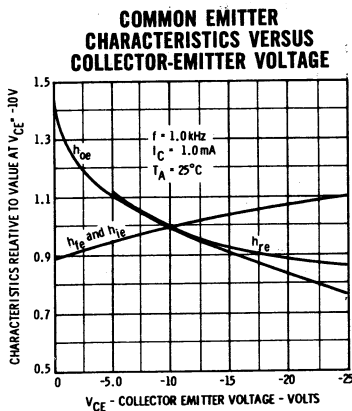
EQUIVALENT INPUT NOISE
CURRENT VERSUS COLLECTOR
CURRENT



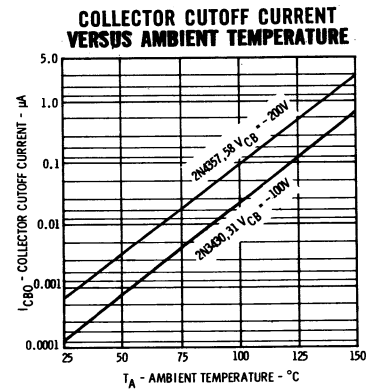
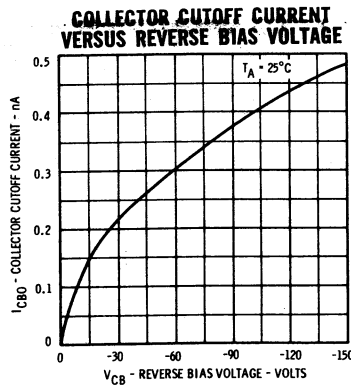
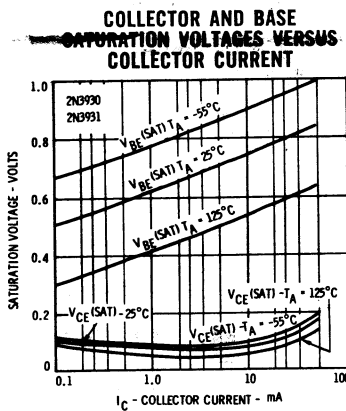
FAIRCHILD TRANSISTORS 2N3930 • 2N3931 • 2N4357 • 2N4358

SMALL SIGNAL CHARACTERISTICS ($f = 1.0 \text{ kHz}$, $T_A = 25^\circ\text{C}$)

SYMBOL	CHARACTERISTIC	MIN.	MAX.	UNITS	TEST CONDITIONS
h_{re}	Small Signal Current Gain	100	400		$I_C = 1.0 \text{ mA}$ $V_{CE} = -10 \text{ V}$
h_{ie}	Input Resistance	2.5	12	kOhms	$I_C = 1.0 \text{ mA}$ $V_{CE} = -10 \text{ V}$
h_{oe}	Output Conductance	5.0	25	μmhos	$I_C = 1.0 \text{ mA}$ $V_{CE} = -10 \text{ V}$



TYPICAL ELECTRICAL CHARACTERISTICS



NOTES:

- These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
- These are steady state limits. The factory should be consulted on applications involving pulsed or low-duty cycle operations.
- These ratings give a maximum junction temperature of 200°C and junction to case thermal resistance of $125^\circ\text{C}/\text{watt}$ (derating factor of $8.0 \text{ mW}/^\circ\text{C}$); junction to ambient thermal resistance of $438^\circ\text{C}/\text{watt}$ (derating factor of $2.28 \text{ mW}/^\circ\text{C}$) for the 2N3920 and 2N4357; junction to case thermal resistance of $70^\circ\text{C}/\text{watt}$ (derating factor of $14.3 \text{ mW}/^\circ\text{C}$); junction to ambient thermal resistance of $250^\circ\text{C}/\text{watt}$ (derating factor of $4.0 \text{ mW}/^\circ\text{C}$) for the 2N3931 and 2N4358.
- This rating refers to a high current point where collector to emitter voltage is lowest.
- Pulse Conditions: length = $300 \mu\text{s}$; duty cycle = 1%.